

## HIT1213

Silicon NPN Epitaxial

REJ03G1609-0100

Rev.1.00

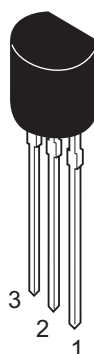
Nov 28, 2007

### Features

- Low frequency power amplifier
- Complementary pair with HIT673

### Outline

RENESAS Package code: PRSS0003DA-A  
(Package name: TO-92 (1))



1. Emitter
2. Collector
3. Base

### Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	50	V
Collector to emitter voltage	$V_{CEO}$	50	V
Emitter to base voltage	$V_{EBO}$	5	V
Collector current	$I_C$	0.5	A
Collector peak current	$I_{C(\text{peak})}$ <sup>Note</sup>	1.0	A
Collector power dissipation	$P_C$	0.4	W
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{\text{stg}}$	-55 to +150	$^\circ\text{C}$

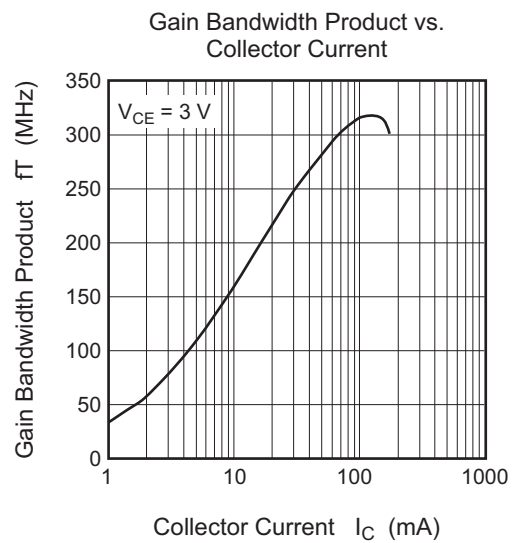
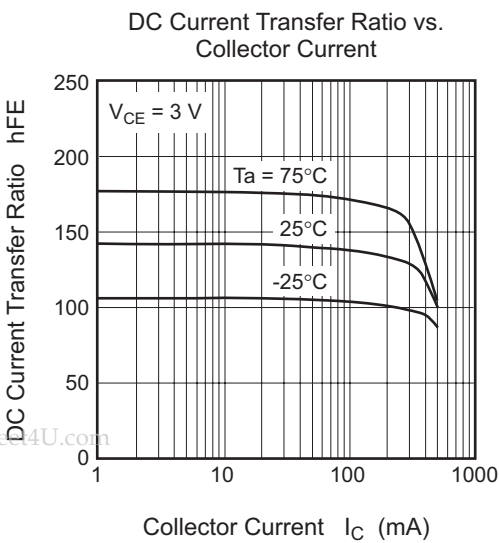
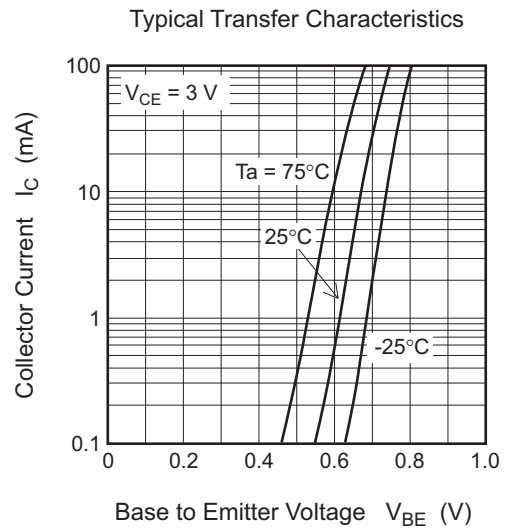
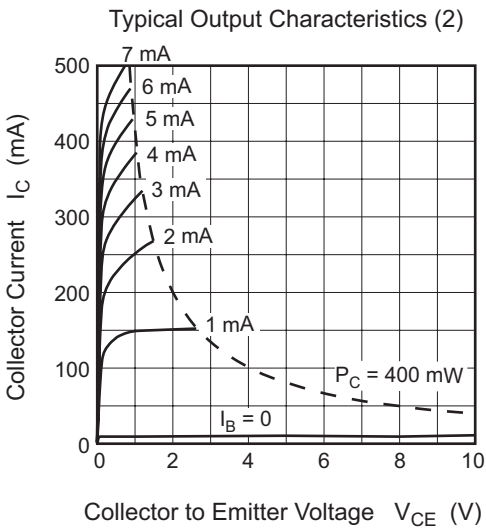
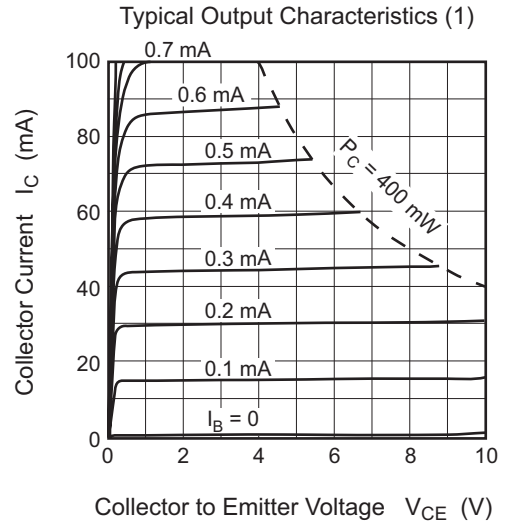
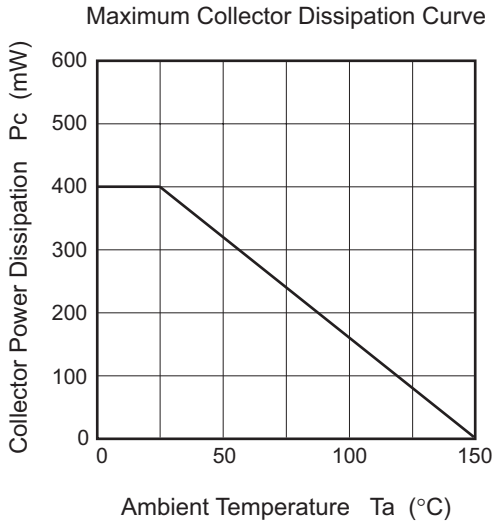
Note:  $PW \leq 10$  ms, Duty cycle  $\leq 20\%$

## Electrical Characteristics

(Ta = 25°C)

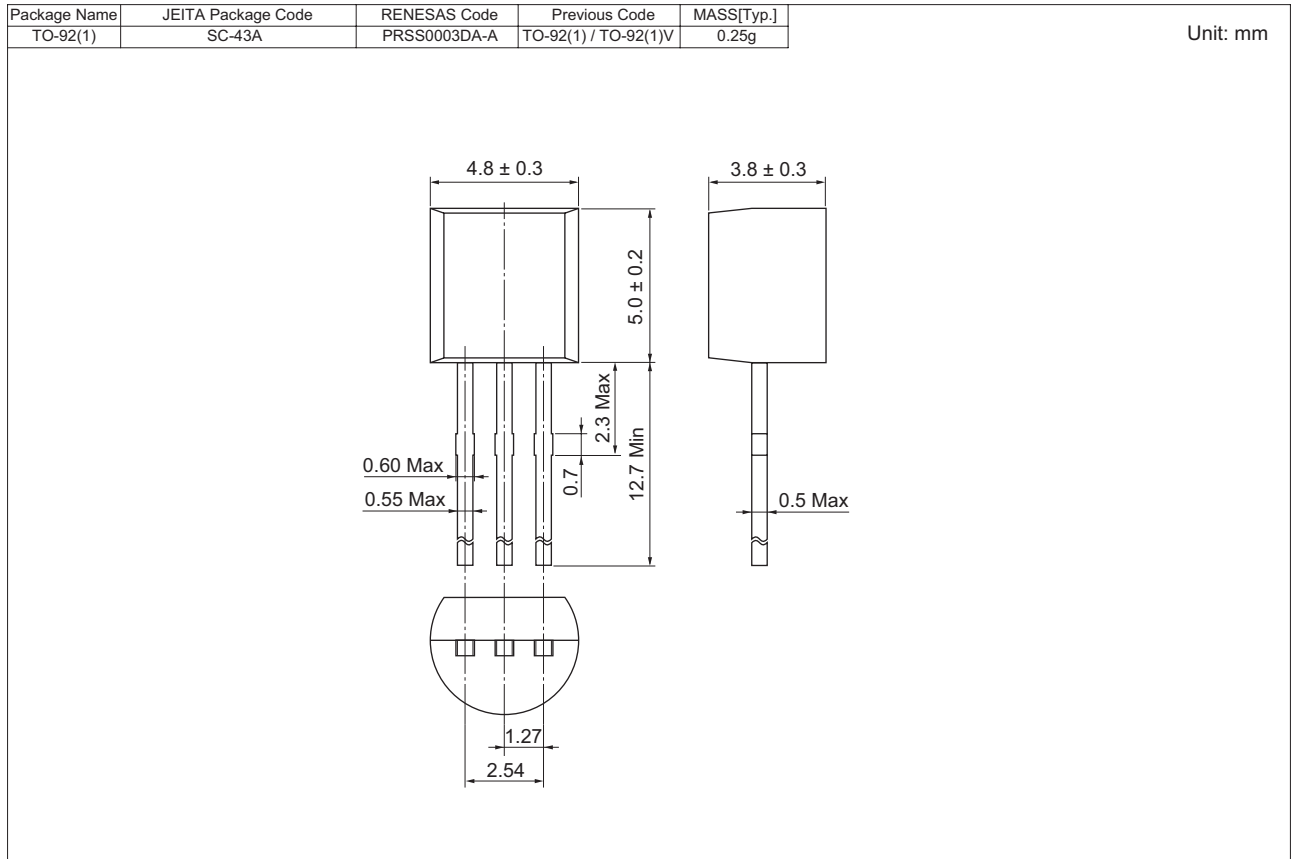
Item	Symbol	Min.	Typ	Max.	Unit	Test Conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	50	—	—	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	50	—	—	V	$I_C = 0.1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—	—	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	$I_{CBO}$	—	—	500	nA	$V_{CB} = 50 \text{ V}, I_E = 0$
Emitter cutoff current	$I_{EBO}$	—	—	500	nA	$V_{EB} = 5 \text{ V}$
DC current transfer ratio	$h_{FE1}$	60	—	320	—	$V_{CE} = 3 \text{ V}, I_C = 10 \text{ mA}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	0.6	V	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$
Base to emitter voltage	$V_{BE(on)}$	—	—	1.2	V	$V_{CE} = 3 \text{ V}, I_C = 10 \text{ mA}$

Main Characteristics



www.DataSheet4U.com

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HIT1213-EQ	2500 pcs.	Bulk, Vinyl Bag
HIT1213-TZ-EQ	2500 pcs.	Hold Box, Radial Taping

Note: This product is designed for consumer use and not for automotive.

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